



	's Docket No	o.: <u>003</u>	401.P114	_						<u>Patent</u>		
In re the	Application	of: Mat	hieu et al.		,							
					(ir	ventor(s	s))					
	ion No.:0		<u> </u>									
Filed: _	March 17,						_					
For: _	METHODS FOR PLANARIZING A SEMICONDUCTOR CONTACTOR											
_		••		(title	e)							
	ANT COMM gton, D.C. 2		R FOR PATEN	TS								
SIR: Tra	ansmitted he	rewith is a	a Preliminary A	mendmen	t for t	he abo	ve applicatio	n.				
	a verified s	statement statement	of this application previously sub- to establish si required.	mitted.								
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Indep. Claims	* 2	Minus	*** 3	0		X39	\$	X78	\$	0		
First Presentation of Multiple Dependent Claim(s)						+130	\$	+260	\$	0		
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5-8-2000 Date

	A check in the amount o Applicant(s) hereby Petii 37 C.F.R. § 1.136(a).	f \$ is attached for presentation of additional claim(s). iion(s) for an Extension of Time of month(s) pursuant to						
	A check for \$	is attached for processing fees under 37 C.F.R. § 1.17.						
		sit Account No. <u>02-2666</u> the amount of \$						
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_X	The Commissioner of Patents and Trademarks is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Accono. No. 02-2666 (a duplicate copy of this sheet is enclosed): X Any additional filing fees required under 37 C.F.R. § 1.16 for presentation of							
	extra cla	· · · · · · · · · · · · · · · · · · ·						
		on or petition fees under 37 C.F.R. § 1.17.						
		BLAKELY SOKOLOFF TAYLOR & ZAFMAN LLP						
Date: _	5/8/00	Andrew C. Chen						
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Atty. Docket No.: 3401.P114



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#4//N

In Re Application of:

Mathieu et al.

Serial No.: 09/527,931

Filed: March 17, 2000

For: Methods for Planarizing a

Semiconductor Contactor

Art Unit: Not Yet Assigned

Examiner: Not Yet Assigned

PRELIMINARY AMENDMENT

Assistant Commissioner of Patents Washington, D.C. 20231

Dear Sir:

Please amend the above-identified application, without prejudice, as

follows:

IN THE CLAIMS

Please cancel claims 1-10.

Please add the following new claims:

11. (New) A method of adjusting a surface of a substrate, the surface defined by contact portions of a plurality of contact elements disposed against the substrate, the method comprising:

applying a force to the substrate to deform the substrate and change the shape of the surface of the substrate from a first shape to a second shape.